

Ratings Maximum operating voltage: 48 V **Connector Current Capacity** Maximum operating current: 6.0 A (not mated under load) 9.0 Operating Temperature Range -25 to 85 °C, relative humidity of 85% or less Max Current 8.0 Materials (1)Insulator: PBT, black 2)Cover: PBT, black 7.0 (3) Terminal: brass, silver plated å (4)Terminal: brass, silver plated **Upper Temperature Limit 85** Operating Current 6.0 (5)Spring contact: phosphor bronze, silver plated 6 Center pin: brass, nickel plated Current (Amps) 5.0 **Electrical Requirements** Dielectric strength: 1 min @ 500 Vac Insulation resistance: 100 MQ @ 500 Vdc minimum Contact resistance: 50 mQ maximum 4.0 Mechanical Requirements (Derated) Insertion force: 0.3-1.5 kaf 3.0 Operating Withdrawal force: 0.3-1.5 kgf Life cycle: 5000 mating cycles while maintaining contact Area resistance: 100 m Ω maximum, insulation resistance: 50 M 2.0 minimum, withstand voltage: 500 Vac, 1 min Terminal strength: 300 gf applied to the terminal for 15 seconds in any direction while maintaining electrical characteristics and 1.0 without damage or excessive looseness of terminals Soldering 0.0 Solderability: 75% minimum coverage when terminals dipped 2mm in 245 ±5 °C solder bath for 3 ±0.5 seconds 75.0 35.0 45.0 55.0 65.0 85.0 95.0 Solder bath durability: no deformation when immersed in 255 ±5 °C Ambient Temperature (°C) up to surface of the board 1.6 mm for 5 seconds or less Solder iron durability: no deformation when exposed to 350 ±10 °C Testing based on IEC 60512-5-2. Max current curve generated with isolated test article under controlled environmental conditions, for 3 ±0.5 seconds and does not take into account external factors such as housings, mating cables, or other circuitry. Operating current curve (derated by 20% of maximum values) accounts for external factors, and manufacturing variation. **Environmental Requirements** Cold test: -25 ±3 °C for 48 hours without deformation Heat test: 85 ± 2 °C, for 48 hours without deformation **Wave Soldering Temperature Profile** Humidity test: 40 ±2 °C, relative humidity 90-95% for 48 hours 245 °C peak (5 seconds max) without deformation Temperature (°C) Pb - Free Flow Profile Solder temperature: 245 °C 120 °C Time: 5 seconds maximum Pre-heat: 100 ~120°C 100 °C Time: 70 seconds maximum Pre-heat Measure point: surface of the solder leads 70 seconds (max) Time (S) Date: Description: Revision: Prepared: Notes: Digitally signed by AG Date: 2019.05.20 08:15:40 -07'00' TENSILITY AG А 5/20/2019 Initial release Function test: no open, no short circuit, no intermittent Verified: tel 1.541.323.3228 800 877.670.7118

> 10.0: ± 0.3 mm

5

Dimensions are in millimeters.

< 1.0: ± 0.1 mm

1.0 to 10.0: ± 0.2 mm

Tolerances:

3

silver plated, thru hole

Connector, dc jack 5.5x2.5 mm, PCB mount, 90°,

Description:

2

Size:

А

Scale: 5:1

 (\bigcirc)

Part number:

54-00134

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